

# MOS FIELD EFFECT TRANSISTOR 2SK3467

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### DESCRIPTION

The 2SK3467 is N-Channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3467	TO-220AB(MP-25)
2SK3467-ZK	TO-263(MP-25ZK)

### FEATURES

- 4.5-V drive available
- Low on-state resistance  
 $R_{DS(on)1} = 6.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 40 \text{ A)}$
- Low gate charge  
 $Q_G = 52 \text{ nC TYP. (} I_D = 80 \text{ A, } V_{DD} = 16 \text{ V, } V_{GS} = 10 \text{ V)}$
- Built-in gate protection diode
- Surface mount device available

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )	$V_{DSS}$	20	V
Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )	$V_{GSS}$	$\pm 20$	V
Drain Current (DC) ( $T_C = 25^\circ\text{C}$ )	$I_{D(DC)}$	$\pm 80$	A
Drain Current (Pulse) <sup>Note</sup>	$I_{D(pulse)}$	$\pm 240$	A
Total Power Dissipation ( $T_A = 25^\circ\text{C}$ )	$P_{T1}$	1.5	W
Total Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_{T2}$	56	W
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

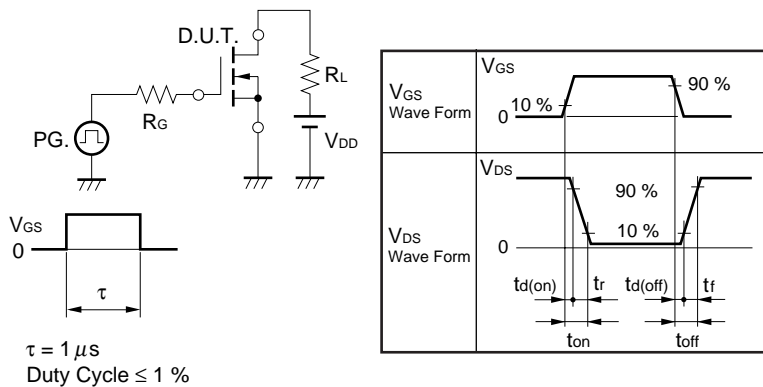
**Note**  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

The information contained in this document is being issued in advance of the production cycle for the device. The parameters for the device may change before final production or NEC Corporation, at its own discretion, may withdraw the device prior to its production.  
**Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.**

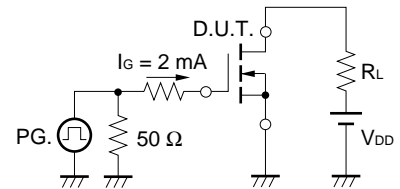
**ELECTRICAL CHARACTERISTICS(T<sub>A</sub> = 25°C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			10	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5		2.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 40 A	14			S
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A		4.8	6.0	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 40 A		7.0	10	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V		2800		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		1200		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		600		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10 V, I <sub>D</sub> = 40 A		26		ns
Rise Time	t <sub>r</sub>	V <sub>GS(on)</sub> = 10 V		22		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		95		ns
Fall Time	t <sub>f</sub>			45		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = 16 V		52		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 10 V		7.2		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = 80 A		18		nC
Diode Forward Voltage	V <sub>F(S-D)</sub>	I <sub>F</sub> = 80 A, V <sub>GS</sub> = 0 V		1.0		V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 80 A, V <sub>GS</sub> = 0 V		50		ns
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt = 100 A/μs		30		nC

**TEST CIRCUIT 1 SWITCHING TIME**

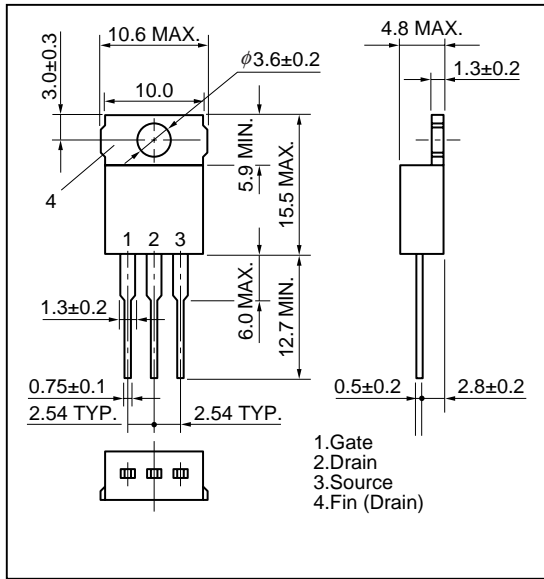


**TEST CIRCUIT 2 GATE CHARGE**

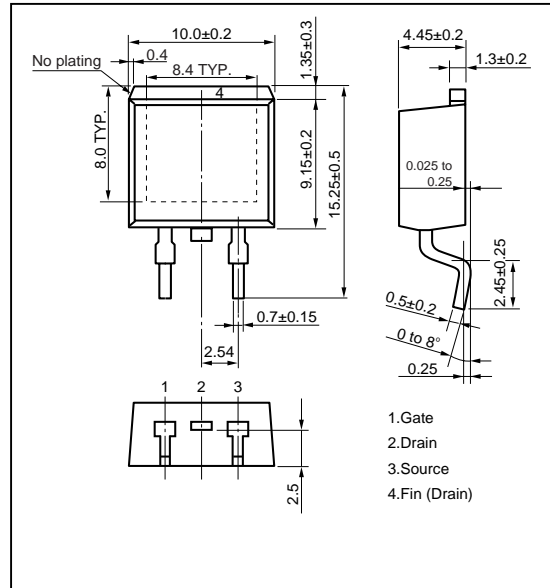


PACKAGE DRAWINGS (Unit : mm)

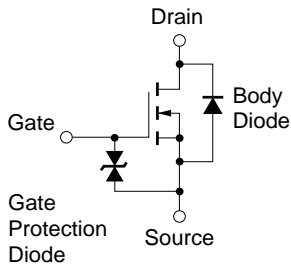
1)TO-220AB (MP-25)



2)TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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